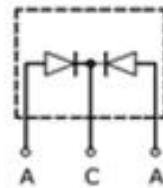


**Parallel (Common Cathode), 1200 30A Fast Recovery
Epitaxial Diode in TO247 package**

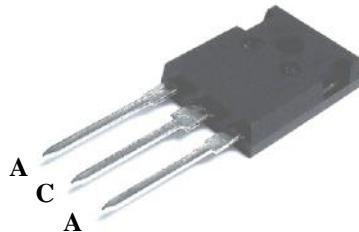
APPLICATIONS

- Switch mode power supplies (SMPS) rectifiers
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders



FEATURES

- Ultrafast recovery time
- Soft recovery characteristics
- Low recovery loss
- Low forward voltage
- High surge current capability
- Low leakage current
- Pb free finished; **RoHS compliant**



MAXIMUM RATINGS (per Diode)

Parameter	Symbol	Value	Units
Repetitive peak reverse voltage	V_{RRM}	1200	V
Continuous forward current $T_C = 110^\circ C$	I_F	30	A
Surge non-repetitive forward current $T_J = 45^\circ C, t_p = 10 \text{ ms}, 50\text{Hz, Sine}$	I_{FSM}	300	
Operating junction and storage temperature	T_j, T_{stg}	-40... +150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Max. Value	Units
Characteristics			
Thermal resistance, junction to case, per Diode	R_{thJC}	1.1	
Thermal resistance, junction to case, per Device		0.6	$^\circ C/W$

Electrical Characteristics (per Diode), at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
Static Characteristics					
Reverse leakage current $V_R = 1200 \text{ V}$, $T_j = 25^\circ\text{C}$	I_R	-	-	100	μA
Forward voltage drop $I_F = 30\text{A}$, $T_j = 25^\circ\text{C}$ $I_F = 30\text{A}$, $T_j = 125^\circ\text{C}$	V_F	-	2.0 1.6	2.5	V

Electrical Characteristics (per Diode), at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
Dynamic Characteristics					
Reverse recovery time $V_R = 30\text{V}$, $I_F = 1\text{A}$, $di_F/dt = -200\text{A}/\mu\text{s}$ $V_R = 600\text{V}$, $I_F = 30\text{A}$, $di_F/dt = -200\text{A}/\mu\text{s}$, $T_j = 25^\circ\text{C}$ $V_R = 600\text{V}$, $I_F = 30\text{A}$, $di_F/dt = -200\text{A}/\mu\text{s}$, $T_j = 125^\circ\text{C}$	t_{rr}	- - -	33 244 444	- - -	ns
Maximum reverse recovery current $V_R = 600\text{V}$, $I_F = 30\text{A}$, $di_F/dt = -200\text{A}/\mu\text{s}$, $T_j = 25^\circ\text{C}$ $V_R = 600\text{V}$, $I_F = 30\text{A}$, $di_F/dt = -200\text{A}/\mu\text{s}$, $T_j = 125^\circ\text{C}$	I_{rrm}	- -	9.1 16.6	- -	A
Reverse recovery charge $V_R = 600\text{V}$, $I_F = 30\text{A}$, $di_F/dt = -200\text{A}/\mu\text{s}$, $T_j = 25^\circ\text{C}$ $V_R = 600\text{V}$, $I_F = 30\text{A}$, $di_F/dt = -200\text{A}/\mu\text{s}$, $T_j = 125^\circ\text{C}$	Q_{rr}	- -	758 4065	- -	nC

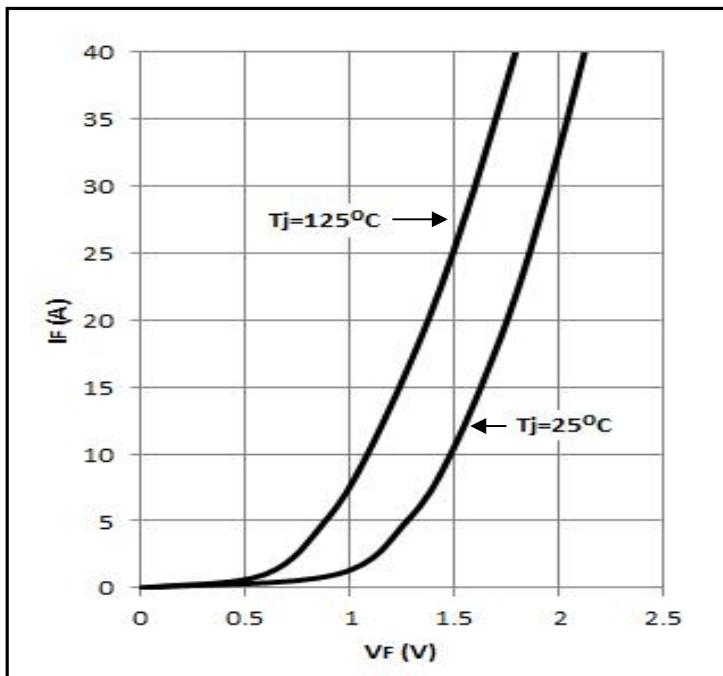
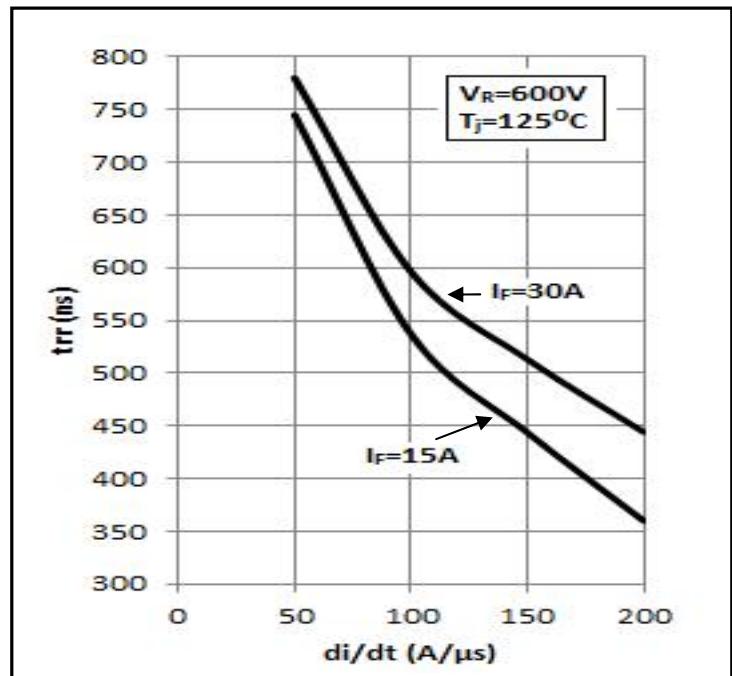
Figure 1 – Forward voltage drop vs forward current

Figure 2 – Reverse recovery time vs di_F/dt


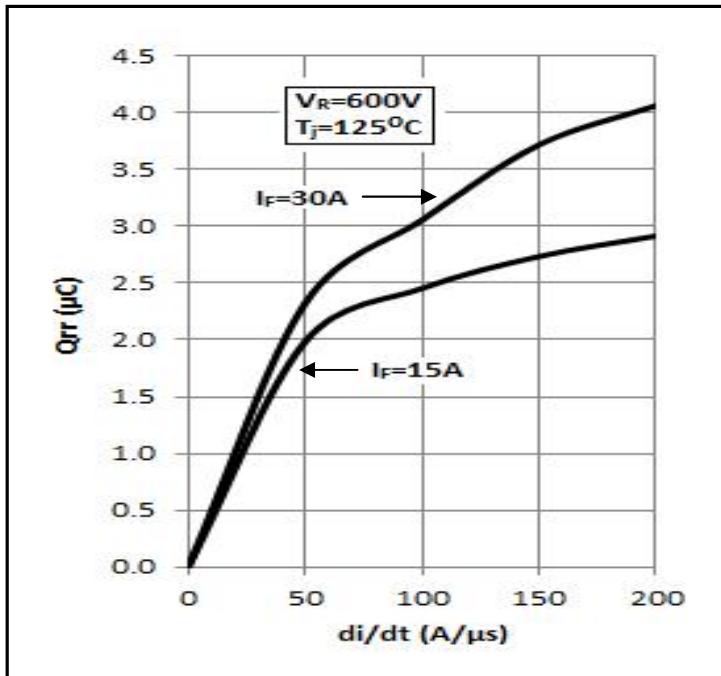
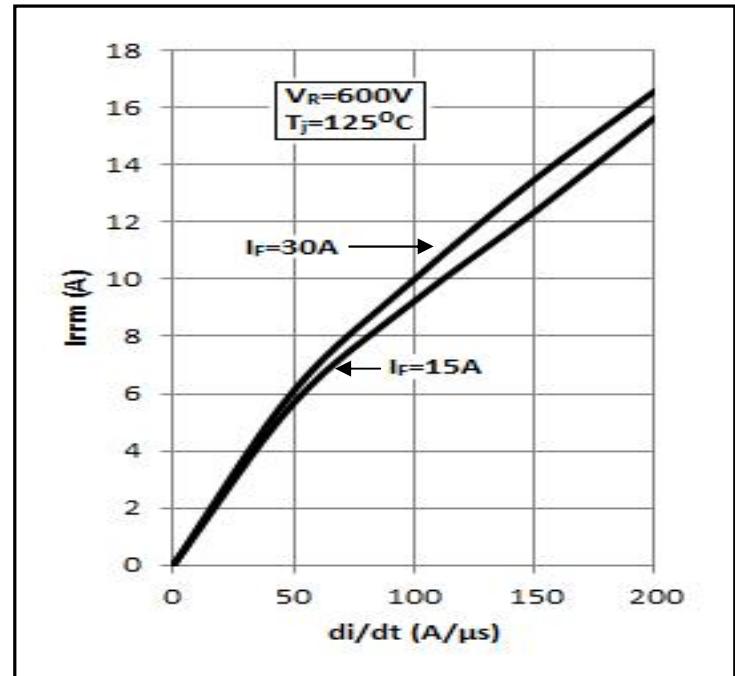
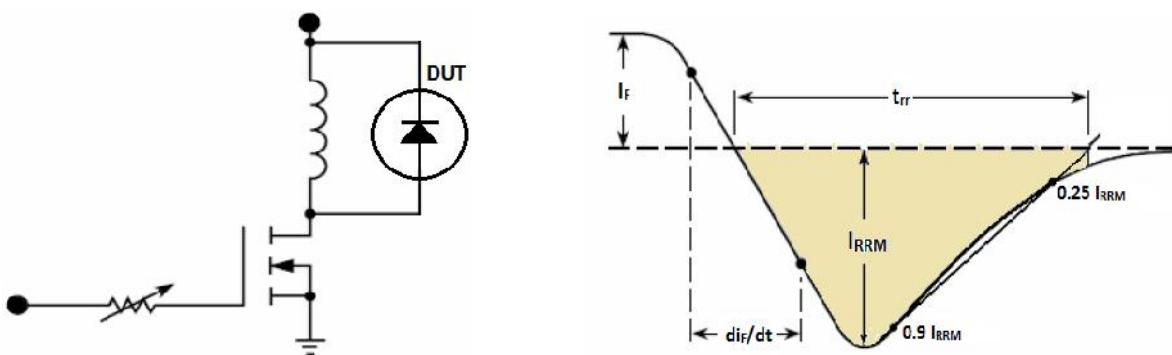
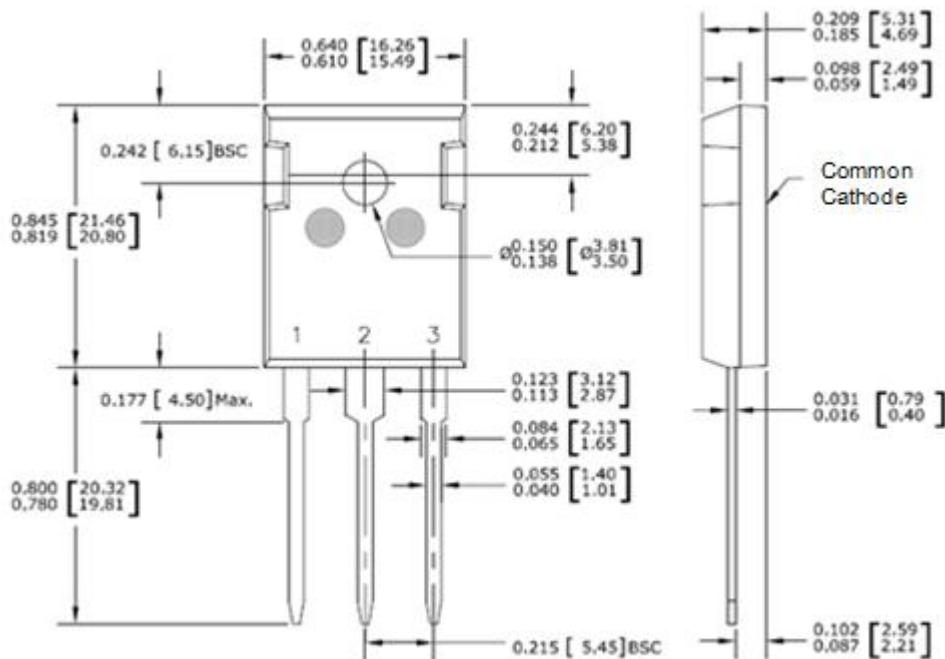
Figure 3 – Reverse recovery charge vs di_F/dt

 Figure 4 – Reverse recovery current vs di_F/dt


Figure 5 – Diode Reverse Recovery Test Circuit and Waveform



Package Outline Drawing



Disclaimer

These specifications may not be considered as a guarantee of components characteristics. Components have to be tested depending on intended application as adjustments may be necessary. The use of **iQXPRZ Power Inc.** components in life support appliances and systems are subject to written approval of **iQXPRZ Power Inc.**